

C0805C120MATACTU

Aliases (C0805C120MATAC7800)

SMD Comm X8G HT150C, Ceramic, 12 pF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.7 mm



General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	11 mg	
Shelf Life	78 Weeks	
MSL	1	

12 pF

100 GOhms

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

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S	0.7mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

Packaging

Packaging Quantity

	2mm +/-0.2mm	Measurement Condition	1 MHz 1.0Vrms
	1.25mm +/-0.2mm	Tolerance	20%
	0.78mm +/-0.10mm	Voltage DC	250 VDC
	0.7mm MIN	Dielectric Withstanding Voltage	625 VDC
	0.5mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
tions		Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
	T&R, 180mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)	
	4000 Dissipation Factor	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	

Insulation Resistance

Specifications

Capacitance

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